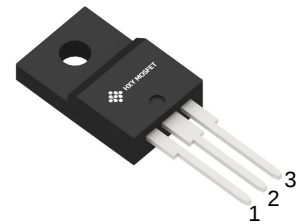


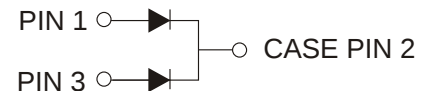


Features

- High frequency operation
- High surge forward current capability
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106



TO-220F(TO-220FP)



Maximum Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{RRM}	Peak repetitive reverse voltage	200	V
I _O	Average rectified output current@ Per leg	16	A
I _{FSM}	Non-Repetitive peak forward surge current 8.3ms half sine wave	100	A
R _{θJC}	Thermal Resistance Between junction and case	2.0	°C/W
T _j	Operating Junction Temperature Range	-55 ~ +150	°C
T _{stg}	Storage Temperature Range	-55 ~ +150	°C

Electrical Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Unit	Test Conditions	MURF1620CTG
Maximum instantaneous forward voltage drop per diode	V _{FM}	V	I _{FM} =8.0A	1.0
Maximum DC reverse current at rated DC blocking voltage per diode	I _{RRM1}	μA	V _{RM} =V _{RRM} T _a =25°C	10
	I _{RRM2}		V _{RM} =V _{RRM} T _a =125°C	100
Reverse Recovery Time	T _{rr}	ns	I _F =0.5A I _{RM} =1A I _{RR} =0.25A	35



Typical Characteristics

FIG1:Io -Tc Curve

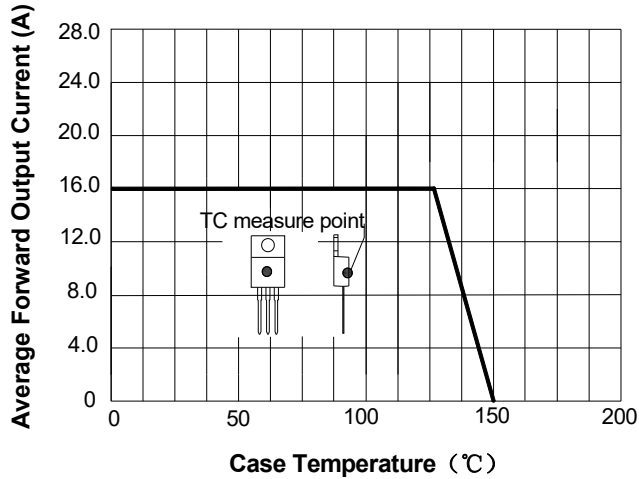


FIG2: Surge Forward Current Capability

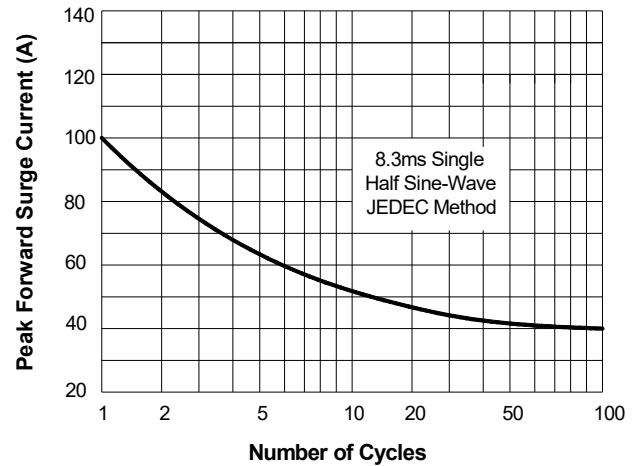


FIG3: Forward Voltage

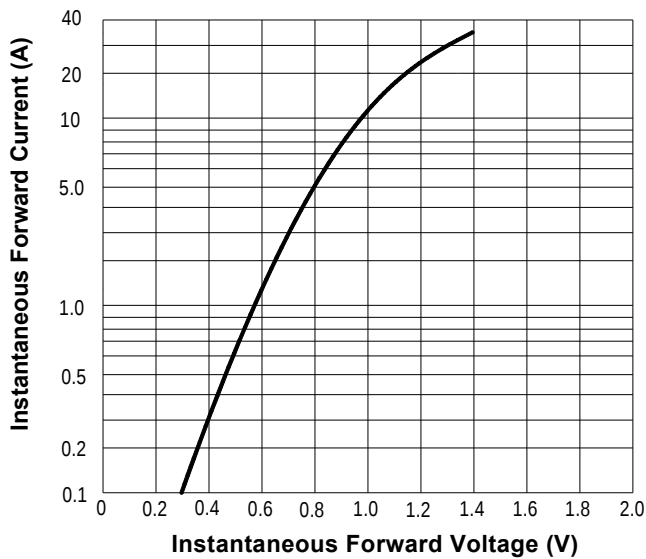


FIG.4: Instantaneous Reverse Characteristics

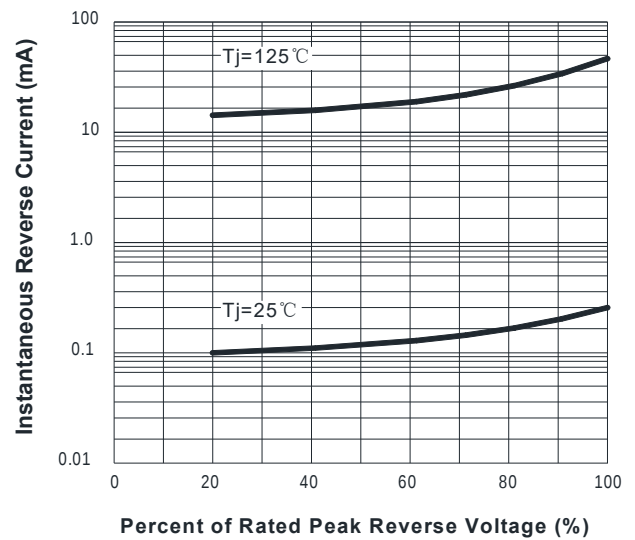
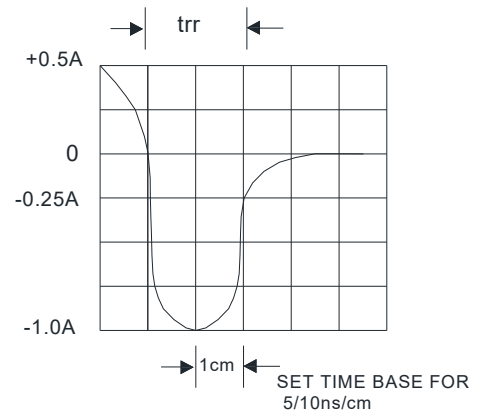
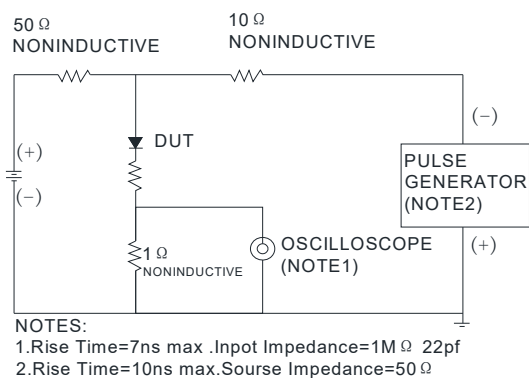
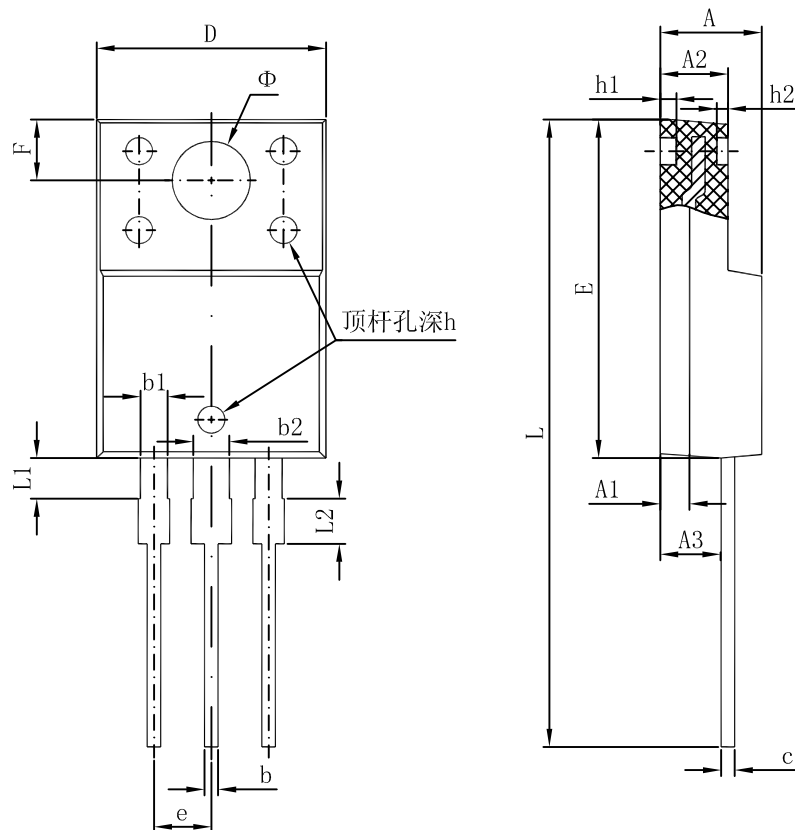


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time





Package Information
TO-220F(TO-220FP)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300 REF.		0.051 REF.	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.500 REF.		0.138 REF.	
h	0.000	0.300	0.000	0.012
h1	0.800 REF.		0.031 REF.	
h2	0.500 REF.		0.020 REF.	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	1.900	2.100	0.075	0.083



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